#### TOSHIBA CMOS DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

# T6A40

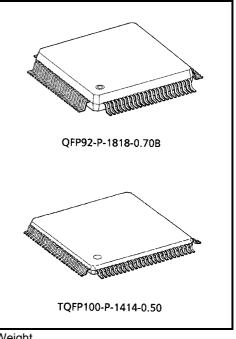
#### ROW DRIVER FOR A DOT MATRIX LCD

The T6A40 is a 68-channel-output row driver for an STN dot matrix LCD. The T6A40 features -28 V LCD drive voltage. The T6A40 is able to drive LCD panels with a duty ratio of up to 1 / 240. It is recommended for use with the T6A39 / T6A39A.

: 68

#### Features

- Display duty application : to 1 / 240
- LCD drive signal
- Data transfer
- : 1-bit bidirectional (1)  $068 \leftarrow 01$ (2)  $068 \rightarrow 01$ (3)  $O1 \rightarrow O34$ ,  $O35 \leftarrow O68$
- LCD drive voltage
- : -8 to -28 V (max -30 V) : 4.5 to 5.5 V
- Operating voltage Operating temperature
- : -20 to 75°C
- LCD drive output resistance : 1.5 kΩ (max) (12.8 V, 1 / 9 bias) : Change on falling edge of LP
- LCD drive output timing



Weight QFP92P-1818-0.70B : 1.45 g (typ.) TQFP100-P-1414-0.50: 0.45 g (typ.)

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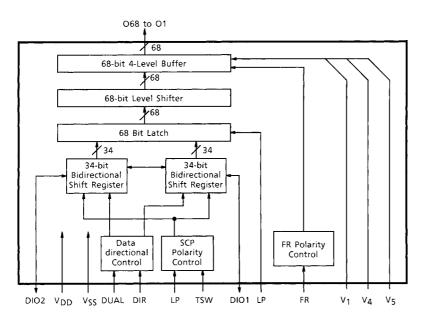
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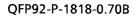
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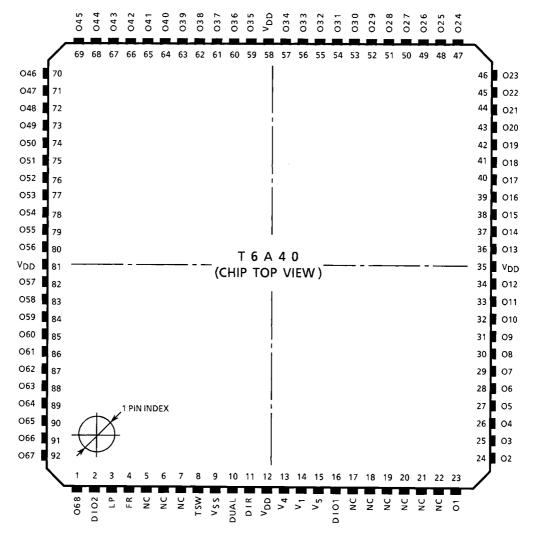
The information contained herein is subject to change without notice.

### **Block Diagram**



#### **Pin Assignment**





# Pin Assignment

TQFP100-P-1414-0.50

		045	044	043	042	041	040	039	038	037	036	035	S	Ŋ	S	034	033	032	031	030	029	028	027	026	025	024			
	/	75	74	73	72	71	70	69	68	67	66	65	64	63	62	61	60	59	58	57	56	55	54	53	52	51	$\overline{\ }$		
046	76													1													50	Q23	1
047	77																										49	022	
048	78																										48	021	
049	79																										47	020	ł
050	80																										46	019	i
051	81																										45	018	i
052	82													ļ													44	017	,
053	83																										43	016	į
054	84																										42	O15	i
055	85													ļ													41	014	ļ
056	86													ì													40	013	;
NC	87												т 6	À	4	0											39	NC	
NC	88										_((	СНІ	P٦	T O F	۷	IEV	V)										38	NC	
NC	89													1													37	NC	
057	90																										36	012	:
058	91													ļ													35	011	
059	92													i													34	010	)
060	93																										33	09	
061	94																										32	08	
062	95													i													31	07	
063	96																										30	06	
064	97				1 PI	N IN	DEX																				29	05	
O65	98	1	イ	×										1													28	04	
066	99	-	$\checkmark$	$\rightarrow$	•									Ì													27	03	
067	100	1	$\rightarrow$																								26	02	
	$\mathbf{i}$	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25			
	_	068	D102	SCP	FR	NC	NC	T SW	Vss	DAUL	NC	DIR	NC		NC	V4	NC	11	V5	D101	NC	NC	NC	NC	NC	01			

## **Pin Functions**

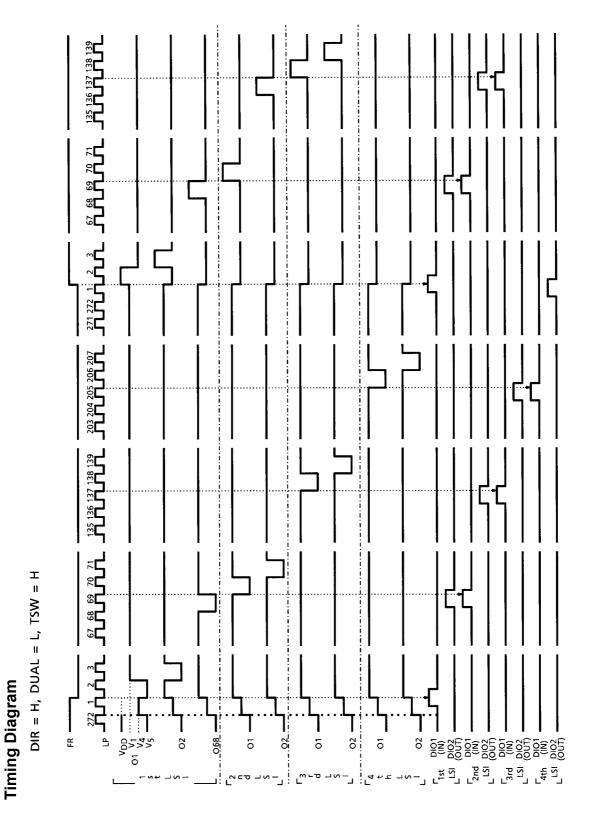
Pin Name	I / O	Functions	Level
O1 to O68	Output	Output for LCD drive signal	$V_{\text{DD}}$ to $V_{\text{5}}$
DIO1, DIO2	I/O	Input / output for shift data	
LP	Input	(Shift Clock Pulse) Input for shift clock pulse	
FR	Input	(Frame) Input for frame signal	
DUAL	Input	(Dual Mode) Terminal for dual input mode or single input mode select	$V_{DD}$ to $V_{SS}$
DIR	Input	(Direction) Input for data flow direction select	
TSW	Input	(Terminal Switch) When tied to $V_{SS}$ : (O1 to O68) output on the rising edge of LP When tied to $V_{DD}$ : (O1 to O68) output on the falling edge of LP	
V <sub>DD</sub>	—	Power supply for internal logic (5 V)	
V <sub>SS</sub>	—	Power supply for internal logic (0 V)	
V <sub>1</sub>	—	Power supply for LCD drive circuit	—
V4	—	Power supply for LCD drive circuit	
V <sub>5</sub>	—	Power supply for LCD drive circuit	

### Relation Between FR, Data Input and Output Level

FR	Data Input (DIO1, DIO2)	Output Level
L	L	V <sub>1</sub>
L	Н	V <sub>5</sub>
Н	L	V <sub>4</sub>
Н	Н	V <sub>DD</sub>

### **Data Input Format**

DUAL			Data Input				
DUAL	DIR	Data	DIO 1	DIO 2			
V <sub>DD</sub>	V <sub>DD</sub>	01  ightarrow 034	IN	IN			
۷UU	vDD	O68  ightarrow O35					
V <sub>SS</sub>	V <sub>DD</sub>	$O1 \rightarrow O68$	IN	OUT			
V <sub>DD</sub>	$V_{SS}$	O68 → O1	OUT	IN			
V <sub>SS</sub>	V <sub>SS</sub>	000 -> 01	001				



# Absolute Maximum Ratings (Ensure that the Following Conditions are Maintained, $V_{DD} \ge V_1 \ge V_4 \ge V_5$ , $V_{SS} = 0$ V)

Item	Symbol	Pin Name	Rating	Unit
Supply Voltage 1	V <sub>DD</sub>	V <sub>DD</sub>	-0.3 to 7.0	V
Supply Voltage 2	V <sub>1</sub>	V <sub>1</sub>	V <sub>DD</sub> - 30.0 to V <sub>DD</sub> + 0.3	V
Supply Voltage 3	V <sub>4</sub>	V <sub>4</sub>	$V_{DD}$ – 30.0 to $V_{DD}$ + 0.3	V
Supply Voltage 4	V5	V5	V <sub>DD</sub> - 30.0 to V <sub>DD</sub> + 0.3	V
Input Voltage	V <sub>IN</sub>	(Note 1)	-0.3 to V <sub>DD</sub> + 0.3	V
Operating Temperature	T <sub>opr</sub>	_	-20 to 75	°C
Storage Temperature	T <sub>stg</sub>	_	-55 to 125	°C

Note 1: FR, DIR, DIO1, DIO2, DUAL, TSW, LP

# Electrical Characteristics DC Characteristics Test Conditions $\begin{pmatrix} Unless Otherwise Noted, V_{SS} = 0 \ V, V_{DD} = 4.5 \ V \ to 5.5 \ V, V_5 = (V_{DD} - 23) \ V \pm 10\%, \ Ta = -20 \ to 75^{\circ}C \end{pmatrix}$

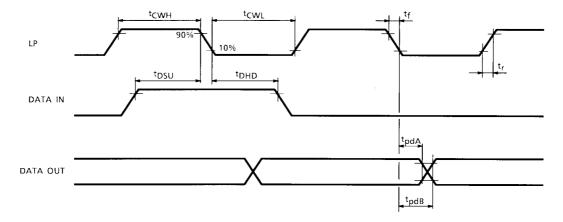
lte	em	Symbol	Test Circuit	Test Co	Min	Тур.	Max	Unit	Pin Name		
Supply Voltage1		V <sub>DD</sub>	_	-	4.5	5.0	5.5	V	V <sub>DD</sub>		
Supply Vol	tage 2	$V_5$	_	-	-	V <sub>DD</sub> -28	_	V <sub>DD</sub> -8.0	V	V <sub>5</sub>	
Input	H Level	V <sub>IH</sub>		(No	te 2)	V <sub>DD</sub> -0.8	_	V <sub>DD</sub>	V	FR, DIR, DIO1, DIO2,	
Voltage	L Level	V <sub>IL</sub>		(Note 2)			_	0.8	v	DUAL, LP, TSW	
Output	H Level	V <sub>OH</sub>		I <sub>OH</sub> = −0.5 mA		V <sub>DD</sub> -0.5	_	V <sub>DD</sub>	V	DIO1, DIO2	
Voltage	L Level	V <sub>OL</sub>		I <sub>OL</sub> = 0.5 mA	Ι	_	0.5	-	2.0., 0.02		
	H Level	R <sub>OH</sub>		$V_{OUT} = V_{DD} - 0$		_	1.2		O1 to O68		
Output Resis-	M Level	R <sub>OM</sub>		$V_{OUT} = V_1 \pm 0.8$	_	_	1.2	kΩ			
tance		R <sub>OM</sub>		$V_{OUT} = V_4 \pm 0.8$		_	1.2				
	L Level	R <sub>OL</sub>		$V_{OUT} = V_5 + 0.5$		_	1.2				
Current Consumption		I <sub>SS</sub>	_	$V_{DD} = 5.5 V$ $V_5 = -22.5 V$ $f_{FR} = 35.5 Hz$ $f_{LP} = 7.1 kHz$ O1 to O68: no load	Input Data: $f_{DIO} = 71 \text{ Hz}$ (Duty: 1 / 100) Input Voltage: $H = V_{DD}$ $L = V_{SS}$ (Note 3)	_	2.0	4.0	μA	V <sub>SS</sub>	

Note 2:  $R_L = 3 k\Omega$ ,  $C_L = 1500 pF$ 

Note 3:  $V_{DD} = 5.0 \text{ V}, V_5 = -7.8 \text{ V}, V_1 = V_{DD} - 1 / 9 (V_{DD} - V_5), V_4 = V_{DD} - 8 / 9 (V_{DD} - V_5)$ 

# <u>TOSHIBA</u>

### **AC Characteristics**



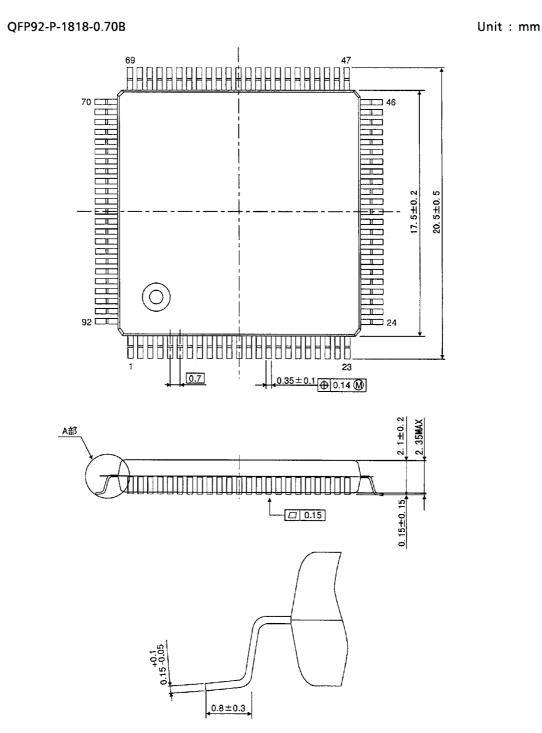
### Test Conditions (V<sub>SS</sub> = 0 V, V<sub>DD</sub> = 4.5 to 5.5 V, V<sub>5</sub> = (V<sub>DD</sub> - 23) V $\pm$ 10%, Ta = -20 to 75°C)

Item	Symbol	Test Condition	Min	Max	Unit
SCP Pulse Width H	t <sub>CWH</sub>	LP	30	_	ns
SCP Pulse Width L	t <sub>CWL</sub>	LP	1	_	μs
Input Rise / Fall Time	t <sub>r</sub> , t <sub>f</sub>	LP, FR, DIO1, DIO2	—	50	ns
Data Set-up Time	t <sub>DSU</sub>	DIO1, DIO2	30	_	ns
Data Hold Time	t <sub>DHD</sub>	DIO1, DIO2	50	_	ns
Output Data Delay Time A	tpdA	DIO1, DIO2 (Note 4	80	_	ns
Output Data Delay Time B	tpdB	DIO1, DIO2 (Note 4	_	1	μs

Note 4: C<sub>L</sub> = 10 pF

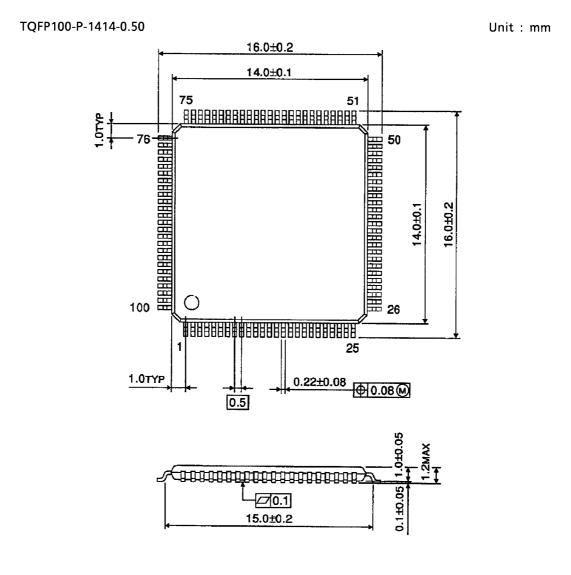
NOTE: Insert the bypass capacitor (0.1  $\mu F)$  between  $V_{DD}$  and  $V_{SS}$  to decrease power supply noise. Place the bypass capacitor as close to the LSI as possible.

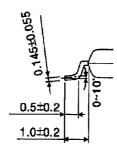
### Package Dimensions



Weight : 1.45 g (Typ.)

### **Package Dimensions**





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